LNJ302GPUJA

Direct Mounting

 \square 5.0 mm \times 2.0 mm

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	ymbol Rating		
Power dissipation	P_{D}	90	mW	
Forward current	I_{F}	30	mA	
Pulse forward current *	I_{FP}	I _{FP} 150		
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Note) *: The condition of I_{FP} is duty 10%, pulse width 10 ms.

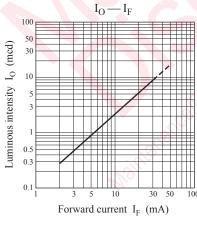
■ Color

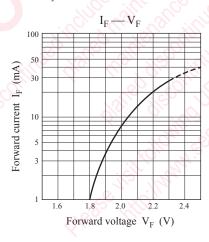
• Yellow Green

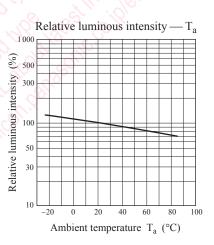
■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

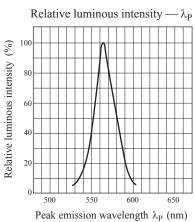
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity	I_{O}	$I_F = 20 \text{ mA}$	1.5	5.0		mcd
Reverse current	I_R	$V_R = 4 V$			10	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$		2.2	2.8	V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 20 \text{ mA}$		565		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$	180	30	1	nm

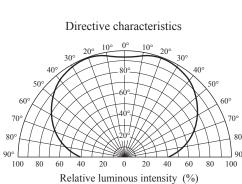
Note) Be careful of the product destruction by static electricity.

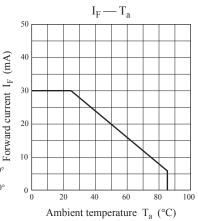








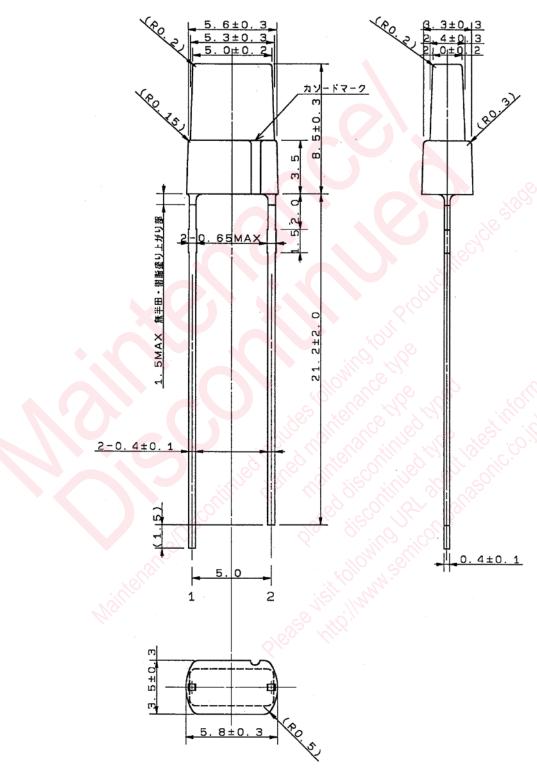




LNJ302GPUJA Panasonic

■ Package (Unit: mm)

LLXFTN2SP020



- Pin name
 - 1: Anode
 - 2: Cathode

2 SHD00612BEK

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